# FAIRCHILD SEMICONDUCTOR

November 2008

# **FDS8812NZ** N-Channel PowerTrench<sup>®</sup> MOSFET 30V, 20A, 4.0m $\Omega$

### Features

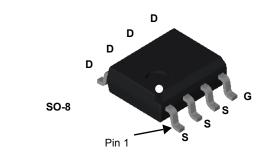
- Max  $r_{DS(on)} = 4.0 m\Omega$  at  $V_{GS} = 10V$ ,  $I_D = 20A$
- Max  $r_{DS(on)}$  = 4.9m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> =18A
- HBM ESD protection level of 6.4KV typical (note 3)
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability
- RoHS compliant

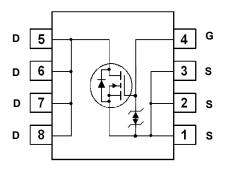


# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.





## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units V
V <sub>DS</sub>	Drain to Source Voltage	30		
V <sub>GS</sub>	Gate to Source Voltage		±20	V
	Drain Current -Continuous	(Note 1a)	20	
D	-Pulsed		80	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 4)	661	mJ
	Power Dissipation	(Note 1a)	2.5	14/
P <sub>D</sub>	Power Dissipation	(Note 1b)	1.0	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

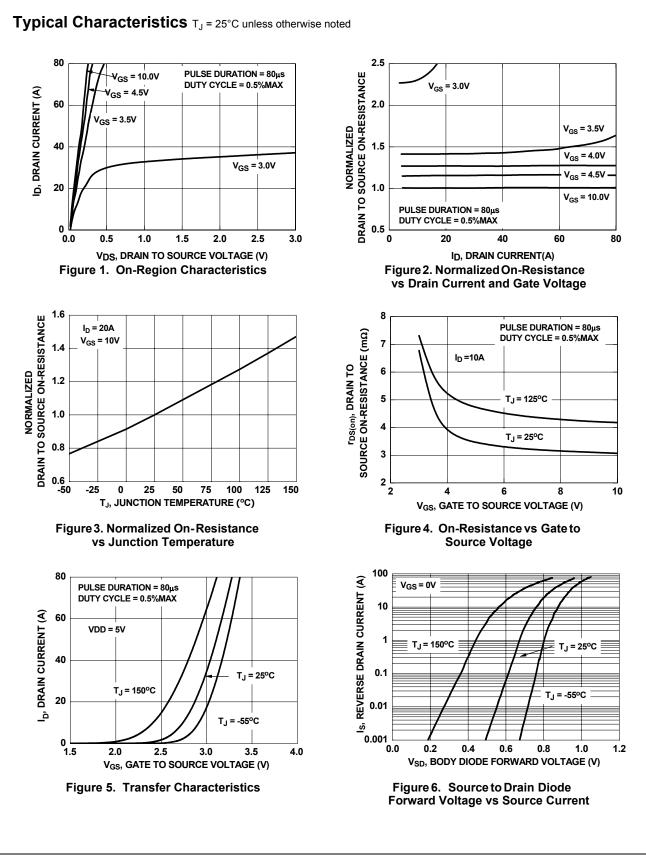
$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	125	

#### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS8812NZ	FDS8812NZ	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	30			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$ , referenced to 25°C		19		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±10	μA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA	1	1.8	3	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			-		
$\Delta T_J$	Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		-7		mV/°C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		3.1	4.0	_
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 18A		3.8	4.9	mΩ
		$V_{GS} = 10V, I_D = 20A, T_J = 125^{\circ}C$		4.2	5.3	-
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5V, I_{D} = 20A$		87		S
Dvnamic	Characteristics					
<i>y</i>						
-				5205	6925	pF
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15V, V_{GS} = 0V,$		5205 945	6925 1260	pF pF
C <sub>iss</sub> C <sub>oss</sub>		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1MHz				•
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance			945	1260	pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	f = 1MHz		945 580	1260	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	f = 1MHz		945 580	1260	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	f = 1MHz f = 1MHz		945 580	1260	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	f = 1MHz f = 1MHz V <sub>DD</sub> = 15V, I <sub>D</sub> = 20A		945 580 1.5	1260 870	pF pF Ω
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> Rg Switching t <sub>d(on)</sub> t <sub>r</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>Gate Resistance</b> Turn-On Delay Time	f = 1MHz f = 1MHz		945 580 1.5 18	1260 870 33	pF pF Ω ns
$C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ <b>Switching</b> $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time	f = 1MHz f = 1MHz V <sub>DD</sub> = 15V, I <sub>D</sub> = 20A		945 580 1.5 18 13	1260 870 33 24	pF pF Ω ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ \hline \\ R_g \\ \hline \\ Switching \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V  V_{DD} = 15V$		945 580 1.5 18 13 55	1260 870 33 24 88	pF pF Ω ns ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time	$f = 1MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		945 580 1.5 18 13 55 12	1260 870 33 24 88 22	pF pF Ω ns ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ \hline \\ C_{rss} \\ \hline \\ R_g \\ \hline \\ Switching \\ \hline \\ t_{d(on)} \\ t_r \\ t_d(off) \\ t_f \\ \hline \\ t_d(off) \\ t_f \\ \hline \\ Q_g \\ \hline \\ Q_g \\ \hline \\ Q_g \\ \hline \\ Q_g \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V  V_{DD} = 15V$		945 580 1.5 18 13 55 12 90	1260 870 33 24 88 22 126	pF pF Ω ns ns ns ns nc
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance <b>g Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V  V_{DD} = 15V$		945 580 1.5 18 13 55 12 90 49	1260 870 33 24 88 22 126	pF pF Ω ns ns ns nc nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V  V_{DD} = 15V$		945 580 1.5 18 13 55 12 90 49 16	1260 870 33 24 88 22 126	pF pF Ω ns ns ns nc nC nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \hline \\ \textbf{Drain-So} \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_{D} = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 15V$ $V_{GS} = 0V \text{ to } 5V$ $I_{D} = 20A$		945 580 1.5 18 13 55 12 90 49 16	1260 870 33 24 88 22 126 69	pF pF Ω ns ns ns nc nC nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$f = 1 MHz$ $f = 1 MHz$ $V_{DD} = 15V, I_D = 20A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V  V_{DD} = 15V$		945 580 1.5 18 13 55 12 90 49 16 18	1260 870 33 24 88 22 126	pF pF Ω ns ns ns nc nC nC nC

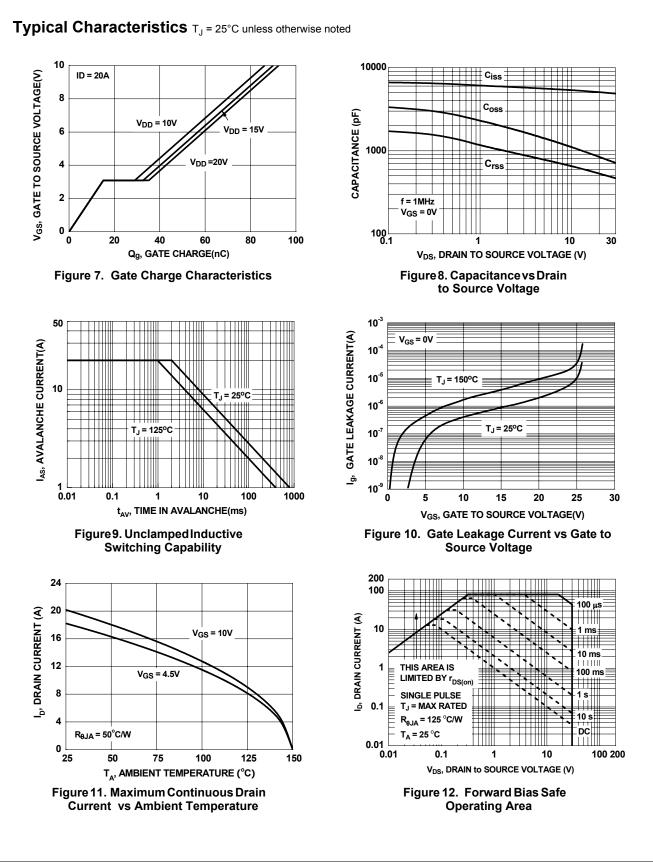
Pulse Test: Pulse Width < 300 us, Duty Cycle < 2%.</li>
 The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.
 Starting T<sub>J</sub> = 25°C, L = 3mH, I<sub>AS</sub> = 21A, V<sub>DD</sub> = 30V, V<sub>GS</sub> = 10V.



FDS8812NZ Rev.C1

3

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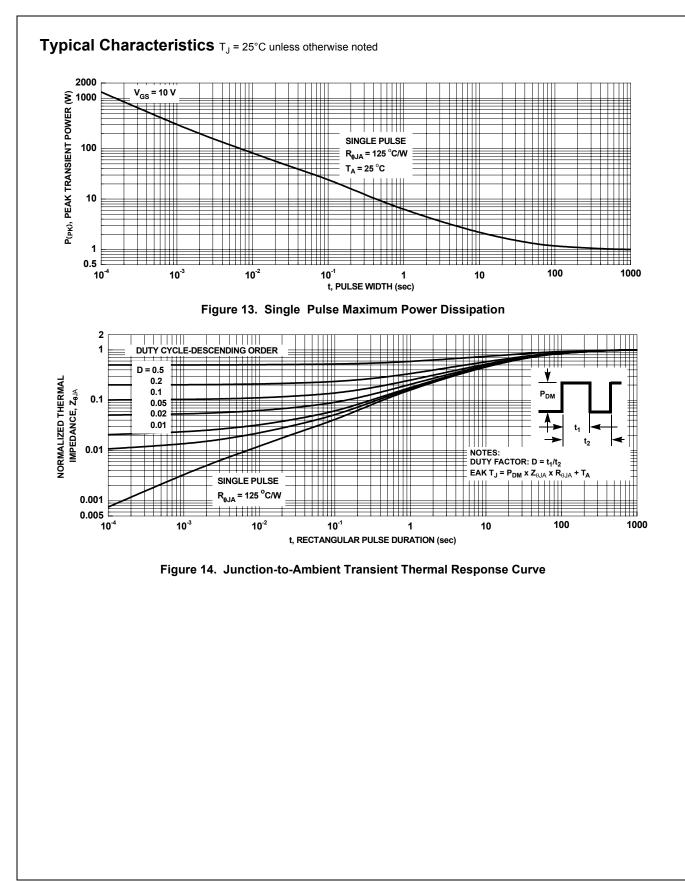


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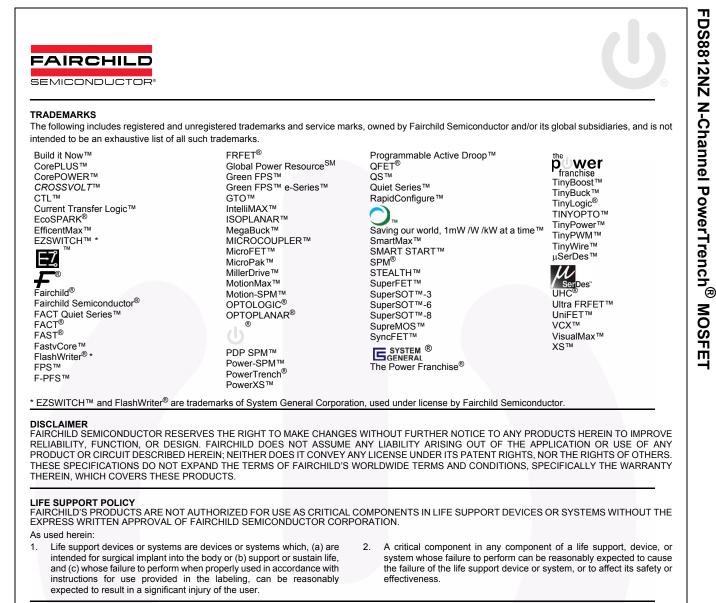
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Datasheet Identification	Product Status	Definition
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